



DMP34M4SPS

30V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°С
-30V	3.8mΩ @ V _{GS} = -10V	-87A
	6.0mΩ @ V _{GS} = -5V	-71A

Description

This new generation MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in notebook battery power managements and load switches.

Applications

Switches

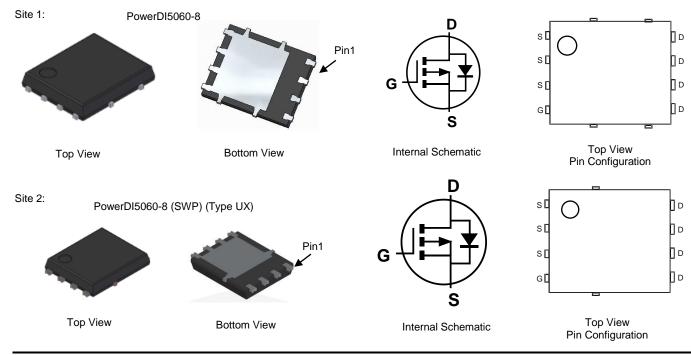
Features

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
 For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Nulliber	Fackage	Qty.	Carrier	
DMP34M4SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMP34M4SPS-13	PowerDI5060-8 (SWP) (Type UX)	2,500	Tape & Reel	

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

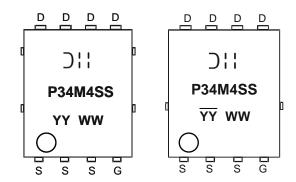
PowerDI is a registered trademark of Diodes Incorporated.

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Marking Information



WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-30	V
Gate-Source Voltage		Vgss	±25	V
Continuous Drain Current, V_{GS} = -10V (Note 5) (Package Limited)	Tc = +25°C T _C = +70°C	lo	-87 -71	A
Continuous Drain Current, V _{GS} = -10V (Note 6)	T _A = +25°C T _A = +70°C	lo	-21 -17	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)		I _{DM}	-350	A
Maximum Continuous Body Diode Forward Current (Note 6)		ls	-2.9	А
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle = 1%)		lsм	-350	A
Avalanche Current, L = 0.1mH (Note 7)		I _{AS}	-60	А
Avalanche Energy, L = 0.1mH (Note 7)		Eas	180	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 8)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R _{θJA}	94	°C/W
Total Power Dissipation (Note 6)		PD	3.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	47	°C/W
Total Power Dissipation (Note 5)		PD	100	W
Thermal Resistance, Junction to Case (Note 5)		R _{θJC}	1.4	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes: 5. Thermal resistance from junction to soldering point (on the exposed drain pad).

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 8. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



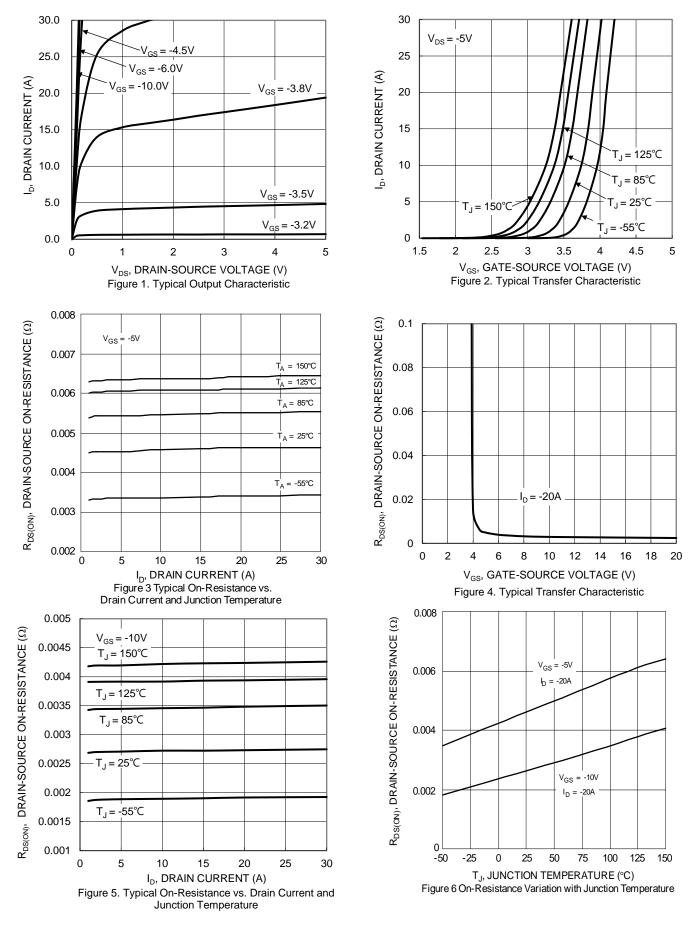
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)	Symbol	IVIIII	тур	Wax	Onit	Test condition
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	I _	V	Vgs = 0V, ID = -250µA
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	Igss			±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)	•					· · · ·
Gate Threshold Voltage	Vgs(th)	-1.6		-2.6	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Statia Duaia Causa On Desistance	P		2.9	3.8		V _{GS} = -10V, I _D = -20A
Static Drain-Source On-Resistance	R _{DS(ON)}		4.9	6.0	mΩ	V _{GS} = -5V, I _D = -20A
Diode Forward Voltage	Vsd	_	-0.7	-1.2	V	VGS = 0V, IS = -1A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	3,775	—	pF	
Output Capacitance	Coss	_	932	—	pF	− V _{DS} = -15V, V _{GS} = 0V − f = 1MHz
Reverse Transfer Capacitance	Crss	_	500	—	pF	
Gate Resistance	Rg	_	21	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	_	127	_	nC	
Gate-Source Charge	Qgs	_	24.5	_	nC	VDS = -15V, VGS = -10V - ID = -20A
Gate-Drain Charge	Qgd		28.5	—	nC	ID = -20A
Turn-On Delay Time	t _{D(ON)}		6.9	—	ns	
Turn-On Rise Time	tR		4.0	—	ns	Vdd = -15V, Vgen = -10V
Turn-Off Delay Time	tD(OFF)		372	_	ns	$R_{GEN} = 3\Omega$, $I_D = -20A$
Turn-Off Fall Time	tF		160	_	ns	7
Reverse Recovery Time	t _{RR}		26.5	_	ns	L= 20.4 dl/dt = 50.0.4 /···
Reverse Recovery Charge	Qrr		37.3		nC	IF = -20A, dl/dt = 500A/µs

 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing. Notes:



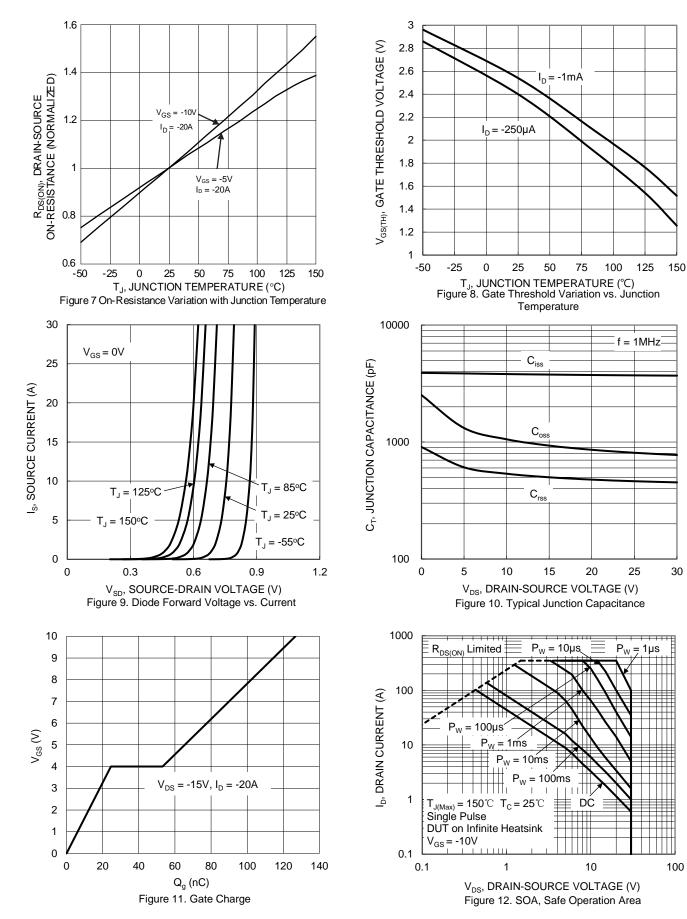
DMP34M4SPS



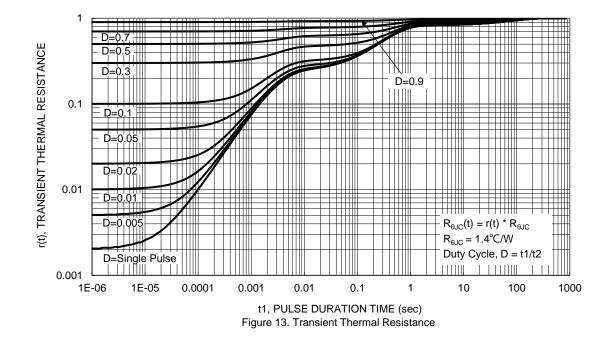
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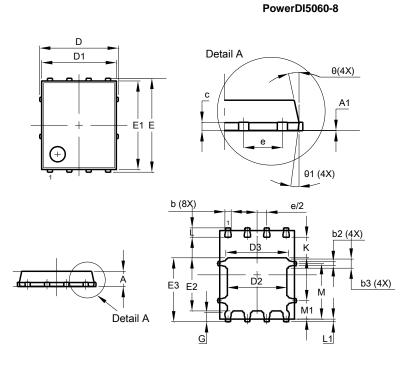




Package Outline Dimensions

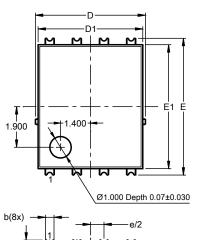
Please see http://www.diodes.com/package-outlines.html for the latest version.

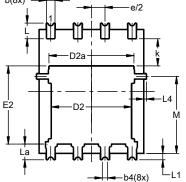
Site 1:



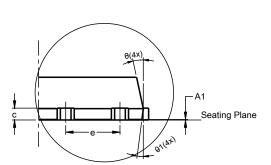
	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
C	0.230	0.330	0.277		
D		5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E	(6.15 BSC			
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е		1.27 BSC			
G	0.51	0.71	0.61		
ĸ	0.51	—	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
AI	All Dimensions in mm				

Site 2:

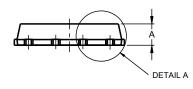




PowerDI5060-8 (SWP) (Type UX)



DETAIL A



PowerDI5060-8 (SWP) (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	C).25REF		
c	0.230	0.330	0.277	
D	-	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BSC	<u> </u>	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC	<u>) </u>	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0	.050RE		
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All	All Dimensions in mm			

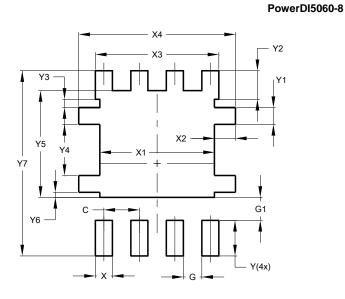
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Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

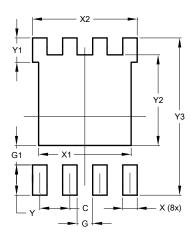
Site 1:



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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